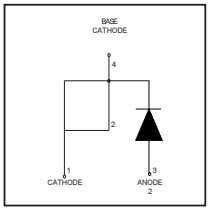
International
IOR Rectifier

PD - 95680A

HFA08PB120PbF

HEXFRED™

Ultrafast, Soft Recovery Diode



V_R = 1200V
V_F (typ.)* = 2.4V
$I_{F\ (AV)}$ = 8.0A
Q_{rr} (typ.)= 140nC
I_{RRM} (typ.) = 4.5A
t_{rr} (typ.) = 28ns
$di_{(rec)\ M}/dt$ (typ.)*= 85A /µs

TO-247AC (Modified)

Features

- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- Specified at Operating Conditions
- Lead-Free

Benefits

- Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count

Description

International Rectifier's HFA08PB120 is a state of the art ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 volts and 8 amps continuous current, the HFA08PB120 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA08PB120 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

Absolute Maximum Ratings

	Parameter	Max	Units
V_R	Cathode-to-Anode Voltage	1200	V
I_F @ T_C = 100°C	Continuous Forward Current	8.0	A
I_{FSM}	Single Pulse Forward Current	130	
I_{FRM}	Maximum Repetitive Forward Current	32	
P_D @ T_C = 25°C	Maximum Power Dissipation	73.5	W
P_D @ T_C = 100°C	Maximum Power Dissipation	29	
T_J T_{STG}	Operating Junction and Storage Temperature Range	- 55 to 150	°C

*125°C

9/16/04

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions	
V_{BR}	Cathode Anode Breakdown Voltage	1200	-	-	V	I_R = 100µA	
V_{FM}	Max. Forward Voltage	-	2.6	3.3	V	I_F = 8.0A	
		-	3.4	4.3		I_F = 16A	See Fig. 1
		-	2.4	3.1		I_F = 8.0A, T_J = 125°C	
I_{RM}	Max. Reverse Leakage Current	-	0.31	10	µA	V_R = V_R Rated	See Fig. 2
		-	135	1000		T_J = 125°C, V_R = 0.8 x V_R Rated	
C_T	Junction Capacitance	-	11	20	pF	V_R = 200V	See Fig. 3
L_S	Series Inductance	-	8.0	-	nH	Measured lead to lead 5mm from pkg body	

Dynamic Recovery Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions	
t_{rr}	Reverse Recovery Time	-	28	-	ns	I_F = 1.0A, di_f/dt = 200A/µs, V_R = 30V	
t_{rr1}	See Fig. 5, 10	-	63	95		T_J = 25°C	I_F = 8.0A
t_{rr2}		-	106	160		T_J = 125°C	V_R = 200V
I_{RRM1}	Peak Recovery Current	-	4.5	8.0	A	T_J = 25°C	di_f/dt = 200A/µs
I_{RRM2}	See Fig. 6	-	6.2	11		T_J = 125°C	
Q_{rr1}	Reverse Recovery Charge	-	140	380	nC	T_J = 25°C	
Q_{rr2}	See Fig. 7	-	335	880		T_J = 125°C	
$di_{(rec)M}/dt1$	Peak Rate of Recovery	-	133	-	A/µs	T_J = 25°C	
$di_{(rec)M}/dt2$	Current During t_b See Fig. 8	-	85	-		T_J = 125°C	

Thermal - Mechanical Characteristics

	Parameter	Min	Typ	Max	Units
T_{lead} ①	Lead Temperature	-	-	300	°C
R_{thJC}	Thermal Resistance, Junction to Case	-	-	1.7	k/W
R_{thJA} ②	Thermal Resistance, Junction to Ambient	-	-	40	
R_{thCS} ③	Thermal Resistance, Case to Heat Sink	-	0.25	-	
Wt	Weight	-	6.0	-	g
		-	0.21	-	(oz)
	Mounting Torque	6.0	-	12	Kg-cm
		5.0	-	10	lbf•in

① 0.063 in. from Case (1.6mm) for 10 sec
② Typical Socket Mount
③ Mounting Surface, Flat, Smooth and Greased

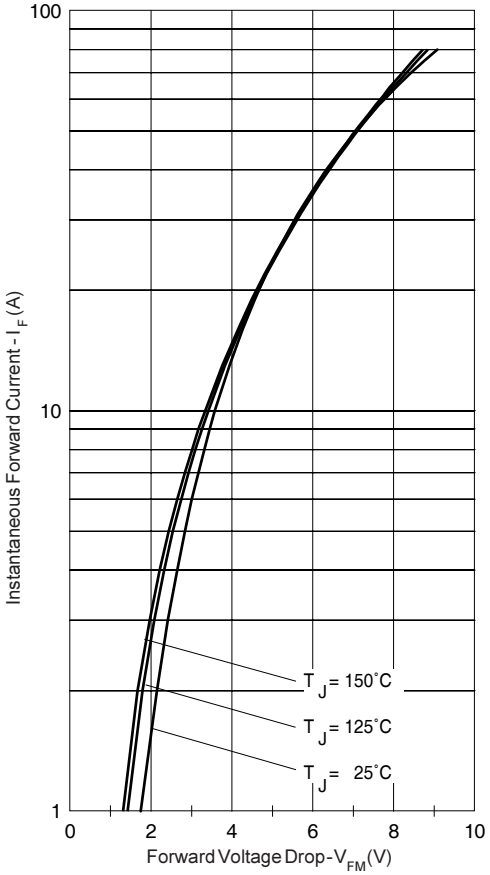


Fig. 1 - Max. Forward Voltage Drop Characteristics

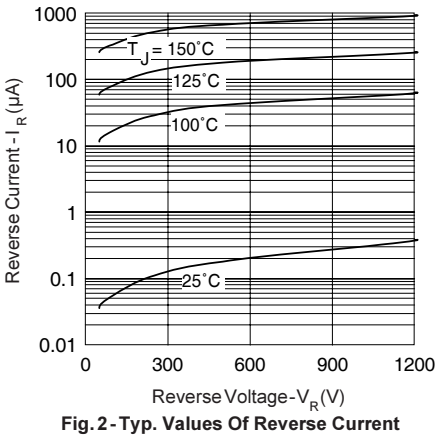


Fig. 2 - Typ. Values Of Reverse Current Vs. Reverse Voltage

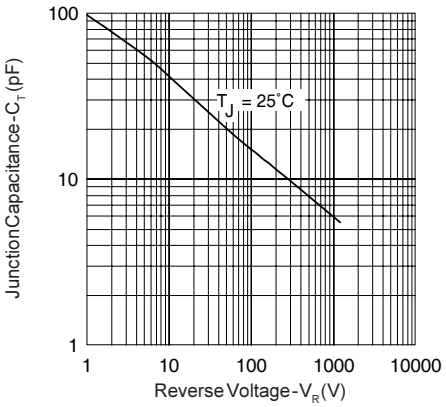


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage

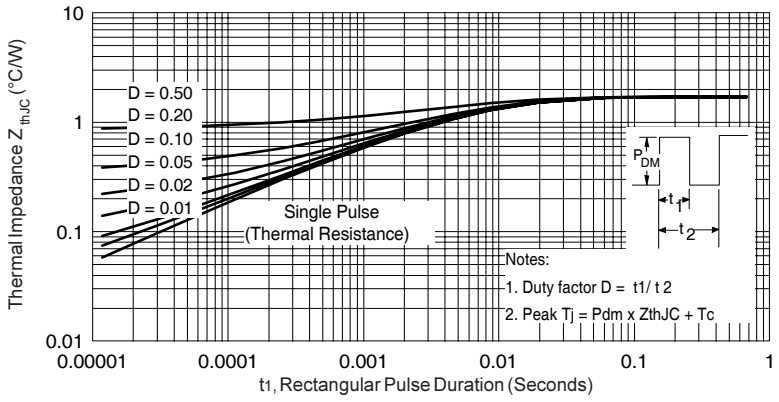


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics

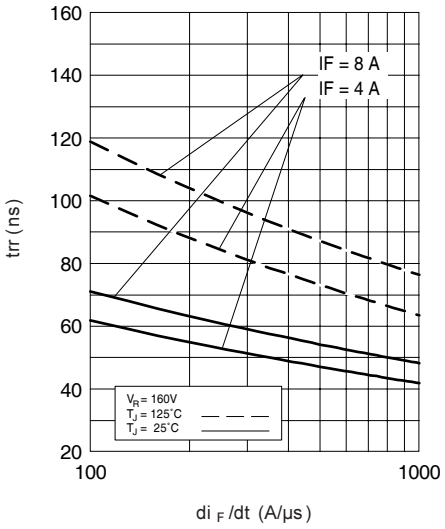


Fig. 5 - Typical Reverse Recovery Vs. di_f/dt

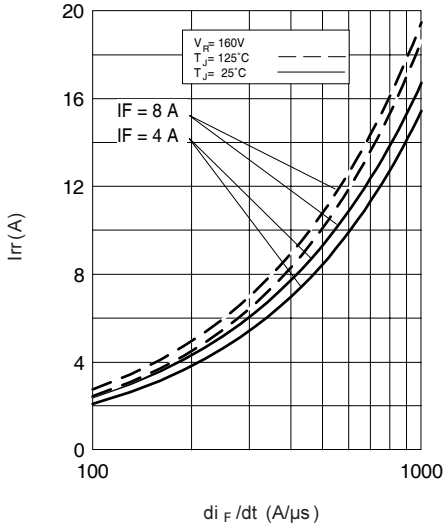


Fig. 6 - Typical Recovery Current Vs. di_f/dt

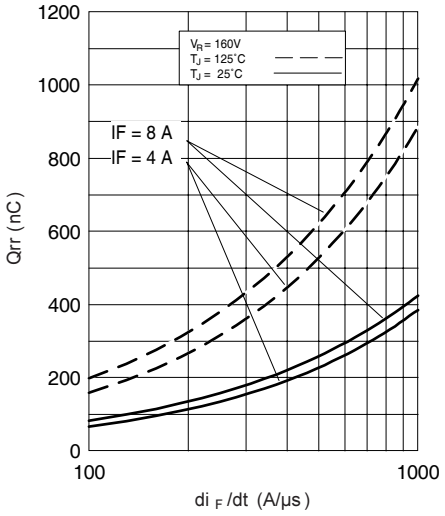


Fig. 8 - Typical Stored Charge vs. di_f/dt

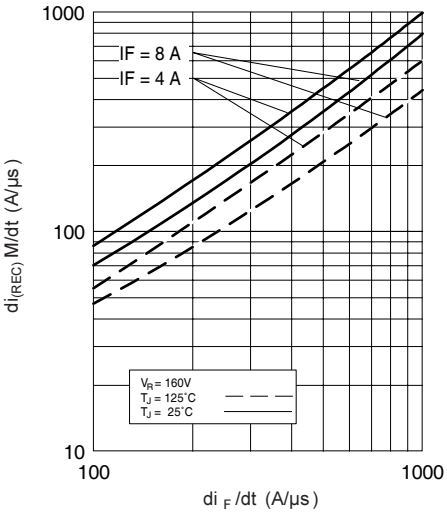


Fig. 7 - Typical $di_{(REC)}$ M/dt vs. di_f/dt

Reverse Recovery Circuit

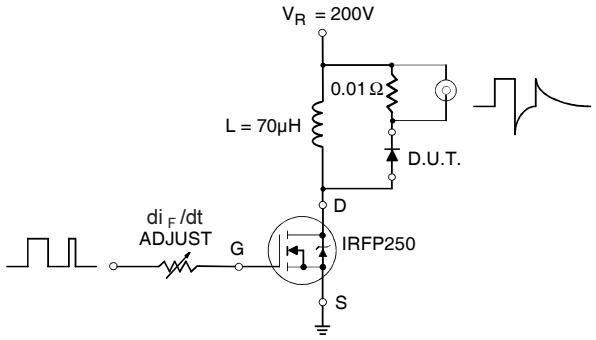
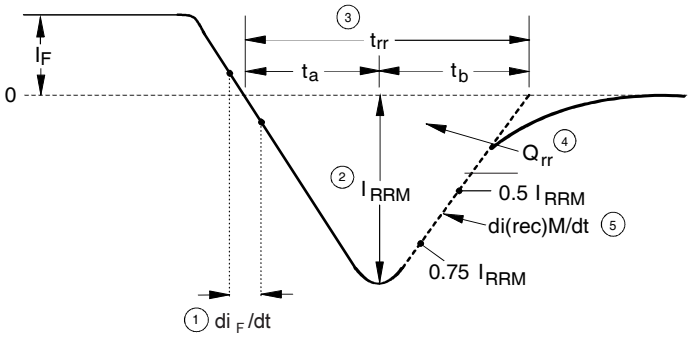


Fig. 9- Reverse Recovery Parameter Test Circuit



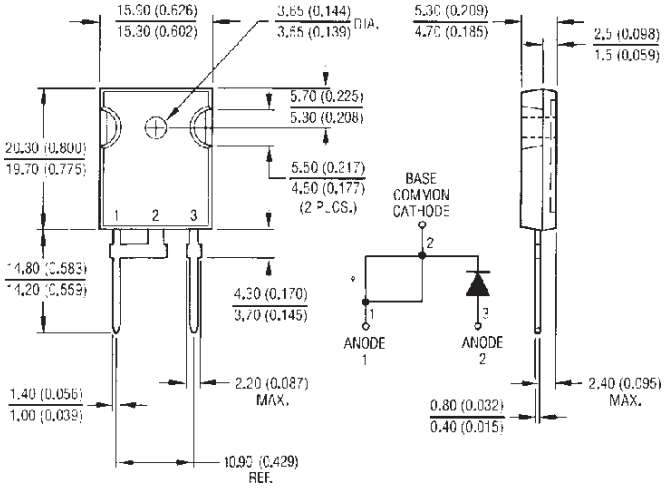
1. di_F/dt - Rate of change of current through zero crossing
2. I_{RRM} - Peak reverse recovery current
3. t_{rr} - Reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current
4. Q_{rr} - Area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

5. $di_{(rec)M}/dt$ - Peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

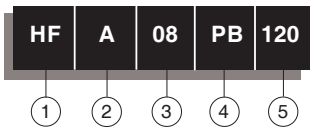
HFA08PB120PbF
Outline Table



Conforms to JEDEC Outline TO-247AC
Dimensions in millimeters and (inches)

Ordering Information Table

Device Code



1	-	Hexfred Family		
2	-	Process Designator	A	= Electron Irradiated
			B	= Platinum Diffused
3	-	Current Rating	(08	= 8A)
4	-	Package Outline	(PB	= TO-247, 2 pins)
5	-	Voltage Rating	(120	= 1200V)

Note: Marking "P" indicates Lead-Free.

Data and specifications subject to change without notice.

International
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10/04

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